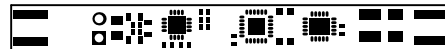
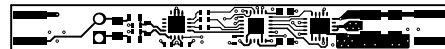


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00457		
PLOT NAME = Top Overlay	GENERATED : 3/15/2016 5:09:34 PM		TEXAS INSTRUMENTS



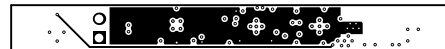
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00457		
PLOT NAME = Top Solder Mask	GENERATED : 3/15/2016 5:09:37 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00457		
PLOT NAME = Top Layer	GENERATED : 3/15/2016 5:09:39 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Mid-Layer 1	TID #: TIDA-00457		
PLOT NAME = Signal Layer 1	GENERATED : 3/15/2016 5:09:42 PM		TEXAS INSTRUMENTS



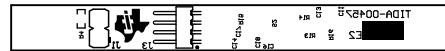
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Mid-Layer 2	TID #: TIDA-00457		
PLOT NAME = Signal Layer 2	GENERATED : 3/15/2016 5:09:45 PM		TEXAS INSTRUMENTS



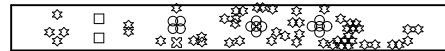
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00457		
PLOT NAME = Bottom Layer	GENERATED : 3/15/2016 5:09:48 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00457		
PLOT NAME = Bottom Solder Mask	GENERATED : 3/15/2016 5:09:51 PM	TEXAS INSTRUMENTS	

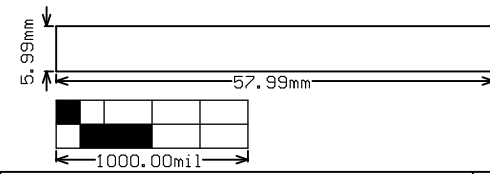


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00457		
PLOT NAME = Bottom Overlay	GENERATED : 3/15/2016 5:09:53 PM		TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Tolerance
○	14	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
☆	51	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	1	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	
□	2	45.28mil (1.150mm)	PTH	Round	Top Layer - Bottom Layer	
	68 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00457		
PLOT NAME = Drill Drawing	GENERATED : 3/15/2016	5:09:56 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00457	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00457		
PLOT NAME = Board Dimensions	GENERATED : 3/15/2016 5:09:59 PM	TEXAS INSTRUMENTS	

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